

# HFH9N90Z / HFA9N90Z

## 900V N-Channel MOSFET

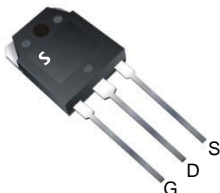
### Features

- ❑ Superior Avalanche Rugged Technology
- ❑ Robust Gate Oxide Technology
- ❑ Very Low Intrinsic Capacitances
- ❑ Excellent Switching Characteristics
- ❑ 100% Avalanche Tested
- ❑ RoHS Compliant
- ❑ Built-in ESD Diode

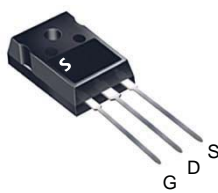
### Key Parameters

Parameter	Value	Unit
$BV_{DSS}$	900	V
$I_D$	9	A
$R_{DS(on), Typ}$	1.12	$\Omega$
$Qg, Typ$	55	nC

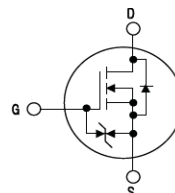
**HFH9N90Z**  
**TO-3P**



**HFA9N90Z**  
**TO-247**



**Symbol**



### Absolute Maximum Ratings $T_C=25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	TO-3P	TO-247	Unit
$V_{DSS}$	Drain-Source Voltage	900		V
$I_D$	Drain Current – Continuous ( $T_C = 25^\circ\text{C}$ )	9.0	9.0 *	A
	Drain Current – Continuous ( $T_C = 100^\circ\text{C}$ )	5.7	5.7 *	A
$I_{DM}$	Drain Current – Pulsed (Note 1)	36	36 *	A
$V_{GS}$	Gate-Source Voltage	$\pm 30$		V
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	900		mJ
$I_{AR}$	Avalanche Current (Note 1)	9.0		A
$E_{AR}$	Repetitive Avalanche Energy (Note 1)	28		mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	4.0		V/ns
$P_D$	Power Dissipation ( $T_C = 25^\circ\text{C}$ )	280	110	W
	- Derate above $25^\circ\text{C}$	2.22	0.88	W/ $^\circ\text{C}$
$V_{ESD(G-S)}$	Gate source ESD(HBM-C=100pF, R=1.5K $\Omega$ )	4		KV
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150		$^\circ\text{C}$
$T_L$	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300		$^\circ\text{C}$

\* Drain current limited by maximum junction temperature

### Thermal Resistance Characteristics

Symbol	Parameter	TO-3P	TO-247	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.45	1.11	$^\circ\text{C}/\text{W}$
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.24	--	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	40	$^\circ\text{C}/\text{W}$

**Electrical Characteristics**  $T_J=25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
<b>On Characteristics</b>						
$V_{GS}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	2.5	--	4.5	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, I_D = 4.5 \text{ A}$	--	1.12	1.4	$\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS} = 50 \text{ V}, I_D = 4.5 \text{ A}$	--	7	--	S
<b>Off Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	900	--	--	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$ , Referenced to $25^\circ\text{C}$	--	0.99	--	$\text{V}/^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 900 \text{ V}, V_{GS} = 0 \text{ V}$	--	--	10	$\mu\text{A}$
		$V_{DS} = 720 \text{ V}, T_C = 125^\circ\text{C}$	--	--	100	$\mu\text{A}$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$	--	--	$\pm 10$	$\mu\text{A}$
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz}$	--	2550	3310	pF
$C_{oss}$	Output Capacitance		--	180	240	pF
$C_{rss}$	Reverse Transfer Capacitance		--	28	36	pF
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-On Time	$V_{DS} = 450 \text{ V}, I_D = 9 \text{ A}, R_G = 25 \Omega$  (Note 4,5)	--	150	310	ns
$t_r$	Turn-On Rise Time		--	70	150	ns
$t_{d(off)}$	Turn-Off Delay Time		--	270	550	ns
$t_f$	Turn-Off Fall Time		--	180	370	ns
$Q_g$	Total Gate Charge	$V_{DS} = 720 \text{ V}, I_D = 9 \text{ A}, V_{GS} = 10 \text{ V}$  (Note 4,5)	--	55	70	nC
$Q_{gs}$	Gate-Source Charge		--	16	--	nC
$Q_{gd}$	Gate-Drain Charge		--	21	--	nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_S$	Maximum Continuous Drain-Source Diode Forward Current		--	--	9	A
$I_{SM}$	Maximum Pulsed Drain-Source Diode Forward Current		--	--	36	
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 9 \text{ A}$	--	--	1.4	V
$t_{rr}$	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_S = 9 \text{ A}, di_F/dt = 100 \text{ A}/\mu\text{s}$	--	660	--	ns
$Q_{rr}$	Reverse Recovery Charge		--	7.8	--	$\mu\text{C}$

**Notes :**

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2.  $L=21\text{mH}, I_{AS}=9\text{A}, V_{DD}=50\text{V}, R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$
3.  $I_{SD}\leq 9\text{A}, di/dt\leq 200\text{A}/\mu\text{s}, V_{DD}\leq BV_{DSS}$ , Starting  $T_J=25^\circ\text{C}$
4. Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$
5. Essentially Independent of Operating Temperature

# Typical Characteristics

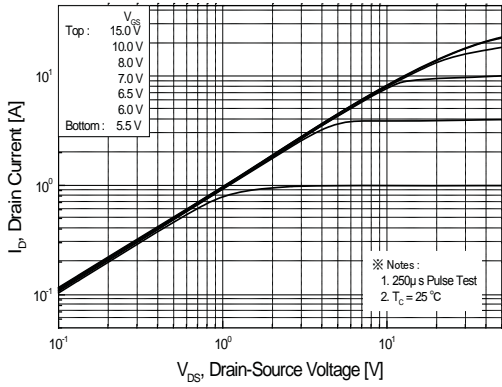


Figure 1. On Region Characteristics

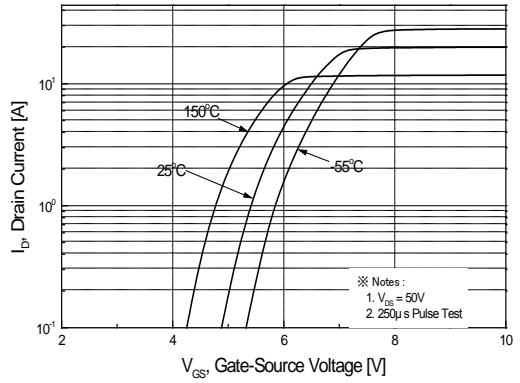


Figure 2. Transfer Characteristics

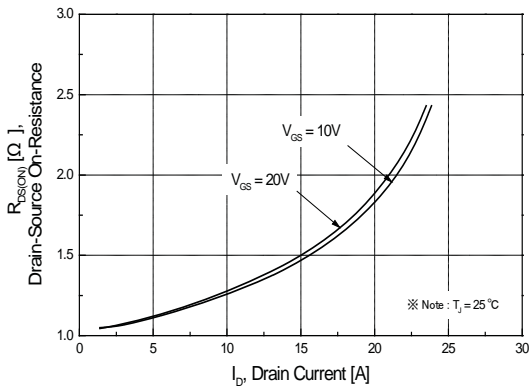


Figure 3. On Resistance Variation vs Drain Current and Gate Voltage

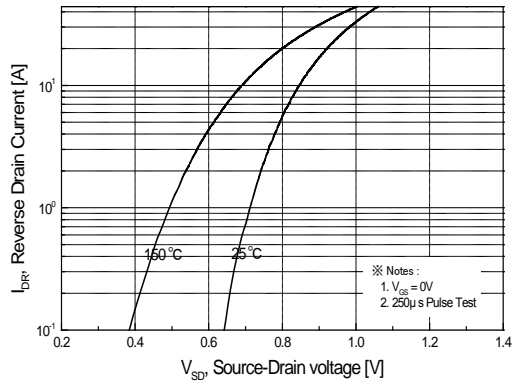


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

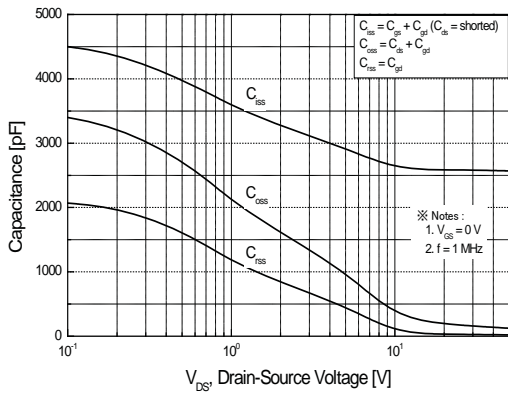


Figure 5. Capacitance Characteristics

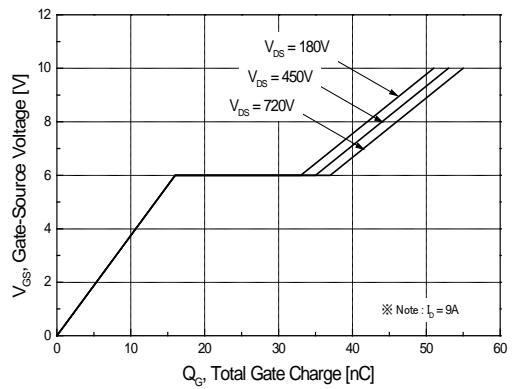


Figure 6. Gate Charge Characteristics

Typical Characteristics (continued)

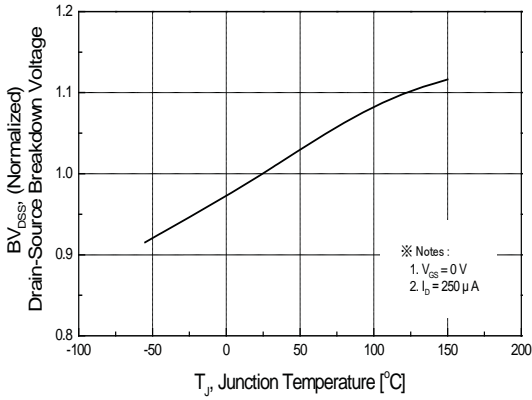


Figure 7. Breakdown Voltage Variation vs Temperature

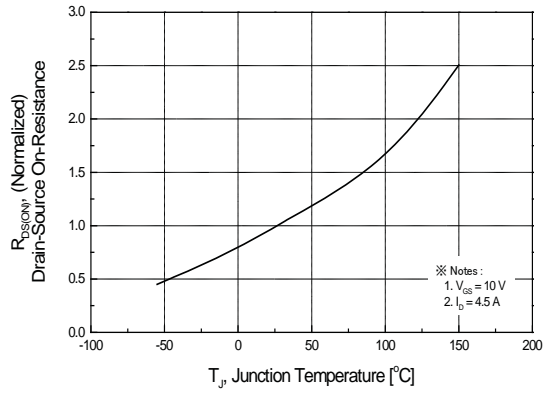


Figure 8. On-Resistance Variation vs Temperature

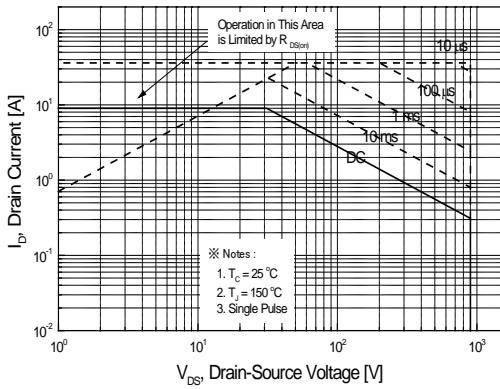


Figure 9-1. Maximum Safe Operating Area for TO-3P

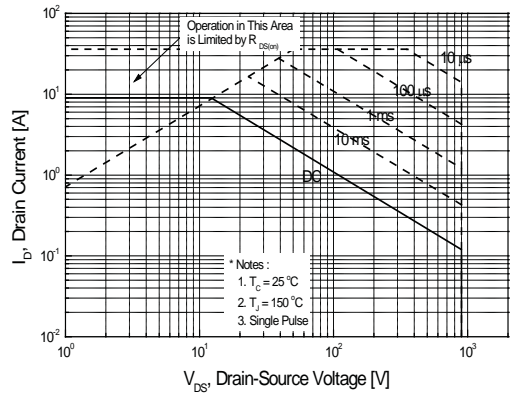


Figure 9-2. Maximum Safe Operating Area for TO-247

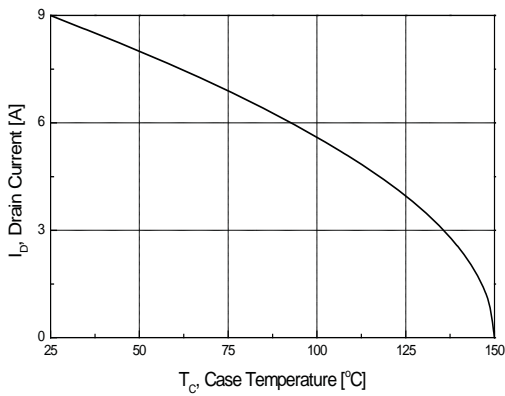


Figure 10. Maximum Drain Current vs Case Temperature

Typical Characteristics (continued)

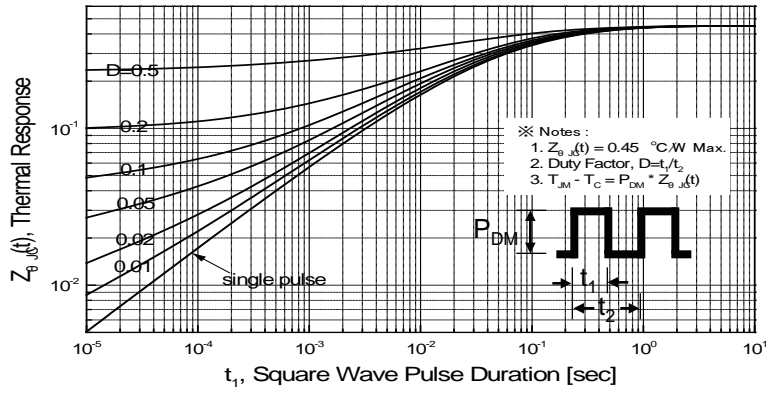


Figure 11-1. Transient Thermal Response Curve for TO-3P

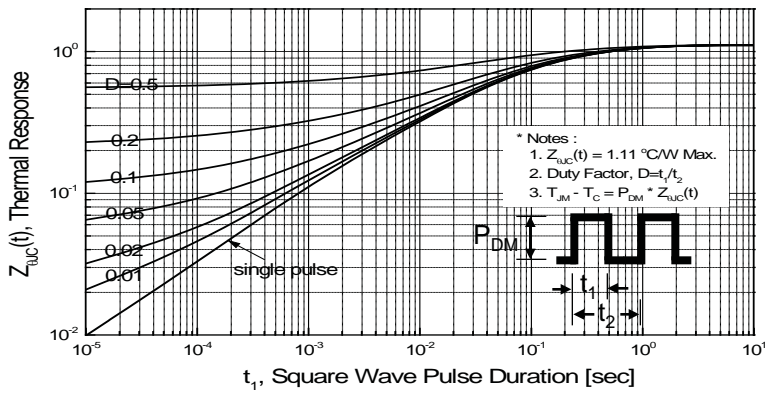


Figure 11-2. Transient Thermal Response Curve for TO-247

Fig 12. Gate Charge Test Circuit & Waveform

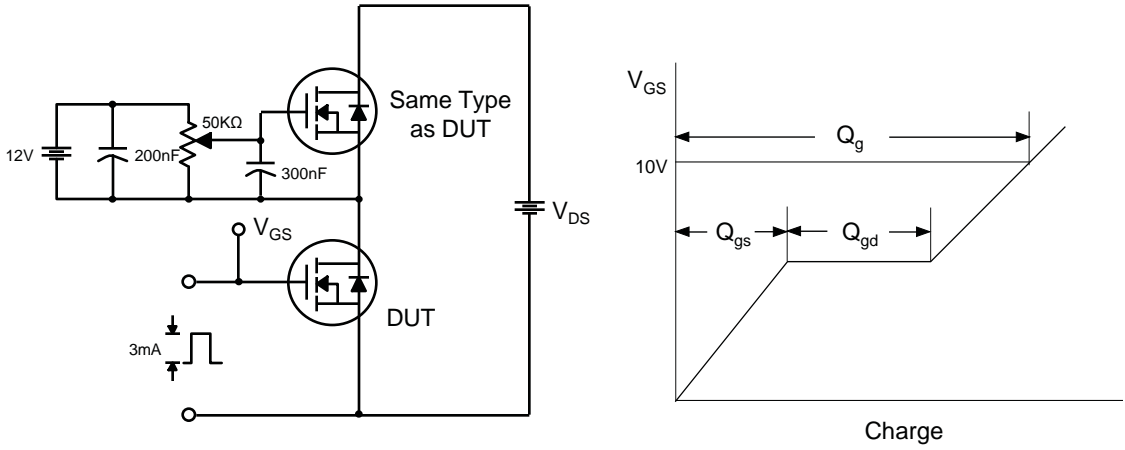


Fig 13. Resistive Switching Test Circuit & Waveforms

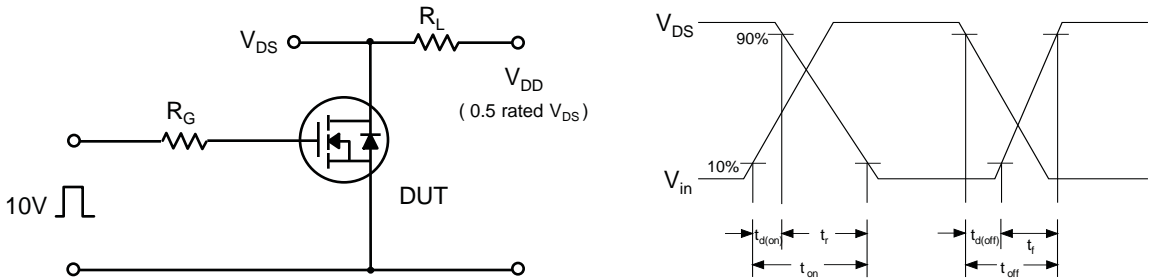


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

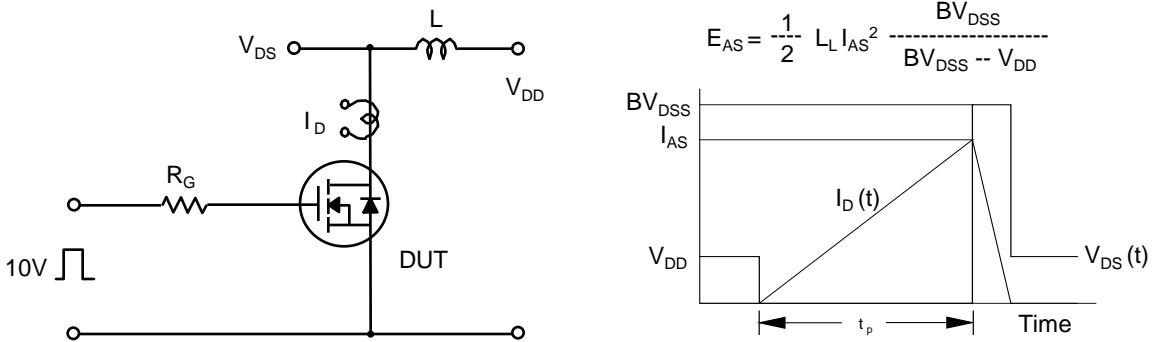
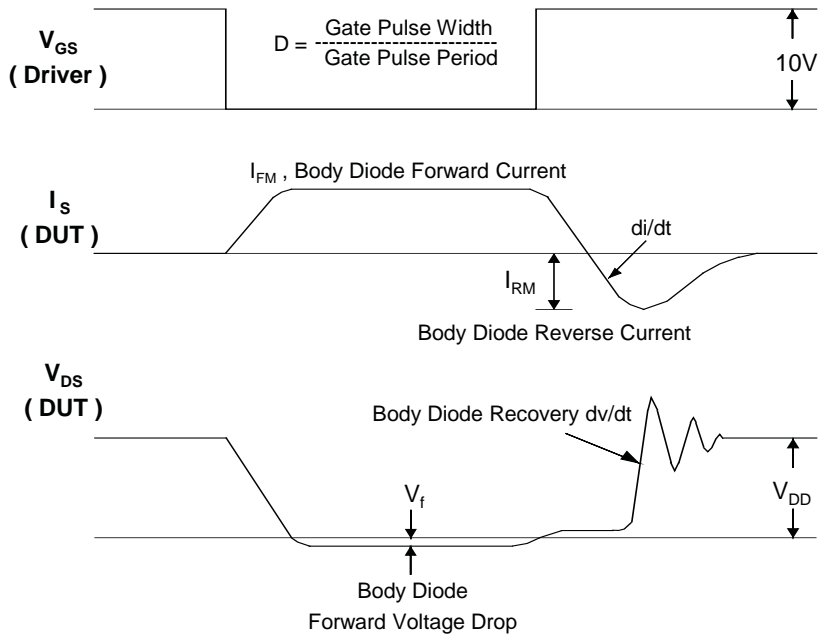
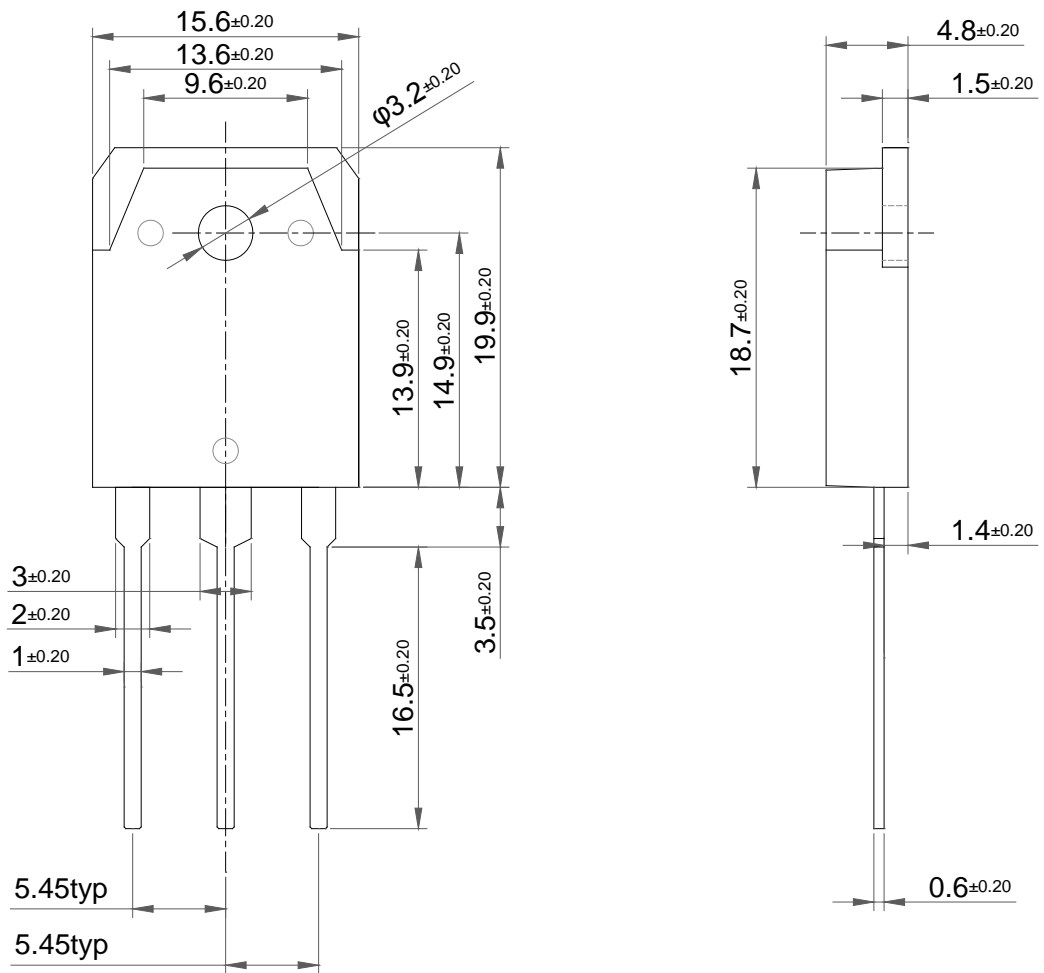


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



# Package Dimension

## TO-3P

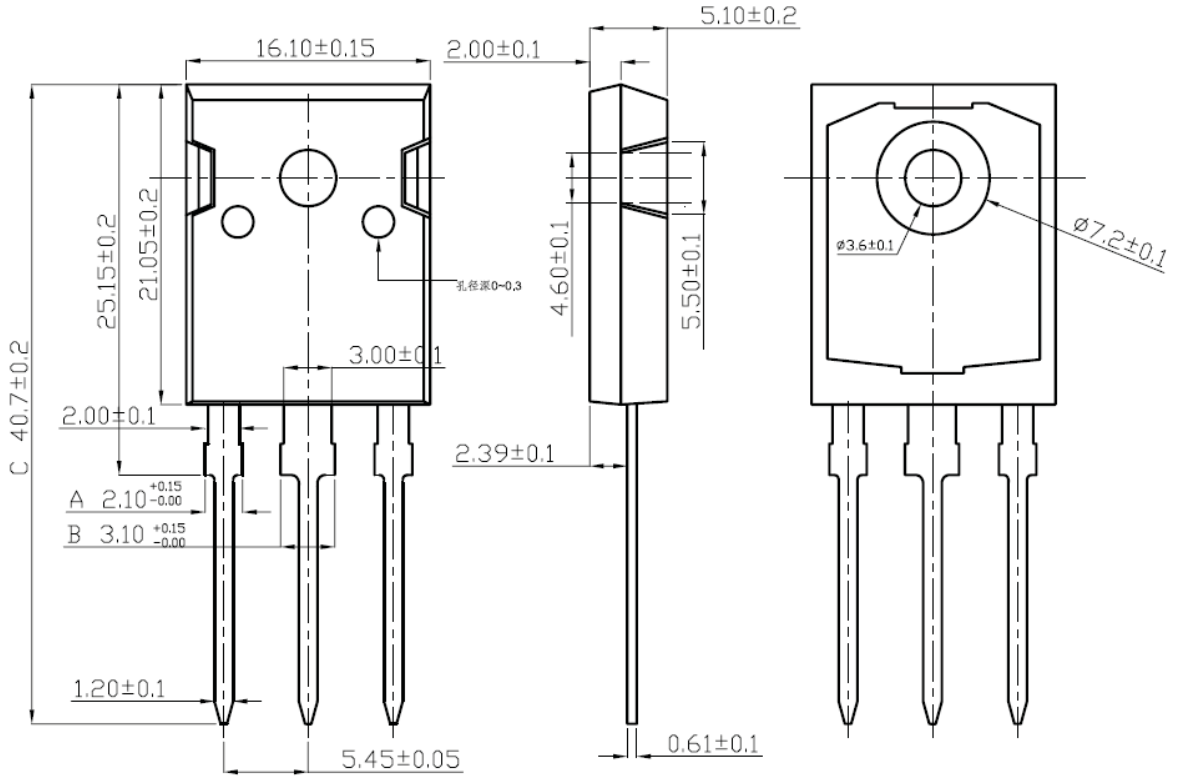


HFH9N90Z\_HFA9N90Z



Package Dimension

TO-247



**Revision History**

<b>VERSION</b>	<b>DESCRIPTION</b>	<b>DATE</b>	<b>APPROVED</b>
0	New Form	20161007	YGCHO
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